INTEGRATED CIRCUITS

DATA SHEET

TDA3664

Very low dropout voltage/quiescent current 5 V voltage regulator

Preliminary specification Supersedes data of 1999 Sep 01 File under Integrated Circuits, IC01 2000 Feb 18





TDA3664

FEATURES

General

- Fixed 5 V, 100 mA regulator
- Supply voltage range up to 33 V (45 V)
- Very low quiescent current of 15 μA (typical value)
- · Very low dropout voltage
- · High ripple rejection
- · Very high stability:
 - Electrolytic capacitors: Equivalent Series Resistance (ESR) <38 Ω at I_{REG} ≤ 25 mA
 - − Other capacitors: 100 nF at 200 μ A ≤ I_{REG} ≤ 100 mA.
- Pin compatible family TDA3662 up to TDA3666.

Protections

- Reverse polarity safe (down to –25 V without high reverse current)
- Negative transient of 50 V ($R_S = 10 \Omega$ and t < 100 ms)
- Able to withstand voltages up to 18 V at the output (supply line may be short-circuited)

- · ESD protection on all pins
- DC short-circuit safe to ground and V_P of the regulator output
- Temperature protection (T_i > 150 °C).

GENERAL DESCRIPTION

The TDA3664 is a fixed 5 V voltage regulator with very low dropout voltage/quiescent current, which operates over a wide supply voltage range.

The regulator is available as:

- TDA3664: SO4 package (automotive)
- TDA3664T: SO8 package (non-automotive)
- TDA3664AT: SO8 package (automotive)
- TDA3664TT: TSSOP8 package (automotive).

Automotive: $V_P \le 50 \text{ V}$ and $-40 \text{ °C} \le T_{amb} \le +125 \text{ °C}$.

Non-automotive: $V_P \le 22 \text{ V}$ and $-40 \text{ °C} \le T_{amb} \le +85 \text{ °C}$.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply		•				
V _P	supply voltage	regulator on				
	TDA3664		3	14.4	45	V
	TDA3664AT		3	14.4	45	V
	TDA3664TT		3	14.4	45	V
	TDA3664T		3	14.4	33	V
Iq	quiescent supply current	V _P = 14.4 V; I _{REG} = 0 mA	_	15	30	μΑ
Voltage regula	itor				•	
V_{REG}	regulator output voltage	$6 \text{ V} \le \text{V}_{\text{P}} \le 22 \text{ V}; \text{I}_{\text{REG}} = 0.5 \text{ mA}$	4.8	5.0	5.2	V
		$8 \text{ V} \le \text{V}_{\text{P}} \le 45 \text{ V}; \text{I}_{\text{REG}} = 0.5 \text{ mA}$	4.75	5.0	5.25	V
		$0.5 \text{ mA} \le I_{REG} \le 100 \text{ mA};$ $V_P = 14.4 \text{ V}$	4.75	5.0	5.25	V
V _{REG(drop)}	dropout voltage	$V_P = 4.5 \text{ V}; I_{REG} = 50 \text{ mA};$ $T_{amb} \le 85 \text{ °C}$	-	0.18	0.3	V

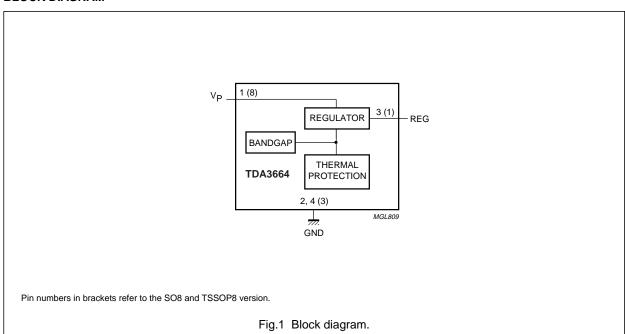
Very low dropout voltage/quiescent current 5 V voltage regulator

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ORDERING INFORMATION

TYPE		PACKAGE	
NUMBER	NAME	DESCRIPTION	VERSION
TDA3664	SO4	plastic small outline package; 4 leads; body width 3.5 mm	SOT223-1
TDA3664T	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1
TDA3664AT			
TDA3664TT	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm	SOT505-1

BLOCK DIAGRAM

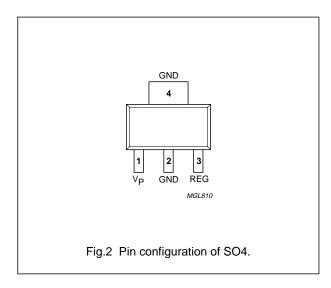


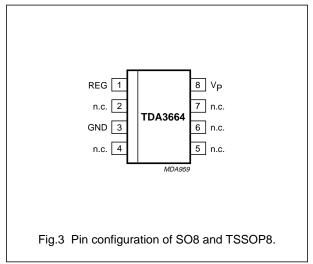
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PINNING

CVMDOL		PIN	DESCRIPTION	
SYMBOL	SO4	SO8	TSSOP8	DESCRIPTION
V _P	1	8	8	supply voltage
GND	2 and 4	3	3	ground
REG	3	1	1	regulator output
n.c.	_	2, 4, 5, 6 and 7	2, 4, 5, 6 and 7	not connected





FUNCTIONAL DESCRIPTION

The TDA3664 is a fixed 5 V regulator which can deliver output currents up to 100 mA. The regulator is available in SO8, TSSOP8 and SO4 packages. The regulator is intended for portable, mains, telephone and automotive applications. To increase the lifetime of batteries, a specially built-in clamp circuit keeps the quiescent current of this regulator very low, also in dropout and full load conditions.

The regulator remains operational down to very low supply voltages, below which it switches off.

A temperature protection is included, which switches the regulator output off at IC temperatures above 150 °C.

A new output structure guarantees the stability of the regulator with an ESR up to 38 Ω . This is very attractive as the ESR of an electrolytic capacitor increases strongly at low temperatures (no expensive tantalum capacitor required).

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _P	supply voltage				
	TDA3664T		_	22	V
	TDA3664		_	45	V
	TDA3664AT		_	45	V
	TDA3664TT		_	45	V
V _{P(rp)}	reverse polarity supply voltage	non-operating	_	-25	٧
P _{tot}	total power dissipation	temperature of copper area			
	TDA3664T	is 25 °C	_	0.8	W
	TDA3664AT		_	0.8	W
	TDA3664TT		_	0.65	W
	TDA3664		_	5	W
T _{stg}	storage temperature	non-operating	-55	+150	°C
T _{amb}	ambient temperature	operating			
	TDA3664T		-40	+85	°C
	TDA3664		-40	+125	°C
	TDA3664TT		-40	+125	°C
	TDA3664AT		-40	+125	°C
Tj	junction temperature	operating	-40	+150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air, soldered in		
	SO8		155	K/W
	TSSOP8		220	K/W
	SO4		100	K/W
R _{th(j-c)}	thermal resistance from junction to case (SO4 only)	in free air	25	K/W

QUALITY SPECIFICATION

In accordance with "SNW-FQ-611E".

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CHARACTERISTICS

 $V_P = 14.4 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; measured in test circuit (see Fig.4); unless otherwise specified.

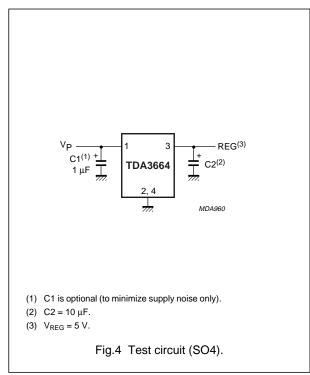
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply volt	age		'	•	•	
V _P	supply voltage	regulator operating; note 1				
	TDA3664		3	14.4	45	V
	TDA3664AT		3	14.4	45	V
	TDA3664TT		3	14.4	45	V
	TDA3664T		3	14.4	33	V
Iq	quiescent current	V _P = 4.5 V; I _{REG} = 0 mA	_	10	-	μΑ
		V _P = 14.4 V; I _{REG} = 0 mA	_	15	30	μΑ
		6 V ≤ V _P ≤ 22 V; I _{REG} = 10 mA	_	0.2	0.5	mA
		6 V ≤ V _P ≤ 22 V; I _{REG} = 50 mA; note 2	_	1.4	2.5	mA
Regulator of	output: pin REG; note 3			•	•	
V_{REG}	output voltage	8 V \leq V _P \leq 22 V, I _{REG} = 0.5 mA; T _{amb} = 25 °C	4.8	5.0	5.2	V
		$8 \text{ V} \le \text{V}_{\text{P}} \le 22 \text{ V}, \text{I}_{\text{REG}} = 0.5 \text{ mA}$	4.75	5.0	5.25	V
		0.5 mA ≤ I _{REG} ≤ 100 mA; note 2	4.75	5.0	5.25	V
		6 V ≤ V _P ≤ 45 V	4.75	5.0	5.25	V
$\Delta V_{REG(line)}$	line regulation voltage	$8 \text{ V} \le \text{V}_{\text{P}} \le 16 \text{ V}; \text{I}_{\text{REG}} = 0.5 \text{ mA}$	_	1	10	mV
		$7 \text{ V} \le \text{V}_{\text{P}} \le 22 \text{ V}; \text{ I}_{\text{REG}} = 0.5 \text{ mA}$	_	1	30	mV
		$7 \text{ V} \le \text{V}_{\text{P}} \le 45 \text{ V}; \text{I}_{\text{REG}} = 0.5 \text{ mA}$	_	1	50	mV
$\Delta V_{REG(load)}$	load regulation voltage	$0.5 \text{ mA} \le I_{REG} \le 50 \text{ mA}$	_	10	50	mV
SVRR	supply voltage ripple rejection	f_i = 120 Hz; $V_{i(ripple)}$ = 1 V (RMS); I_{REG} = 0.5 mA	50	60	-	dB
V _{REG(drop)}	dropout voltage	$V_P = 4.5 \text{ V}; I_{REG} = 50 \text{ mA}; T_{amb} \le 85 ^{\circ}\text{C}$	_	0.18	0.3	V
I _{REG(crl)}	current limit	V _{REG} > 4.5 V	0.17	0.25	_	Α
V _{REG(stab)}	long-term stability		-	20	-	mV/1000 h
I _{LO(rp)}	output leakage current at reverse polarity	$V_P = -15 \text{ V}, V_{REG} \le 0.3 \text{ V}$	_	1	500	μΑ

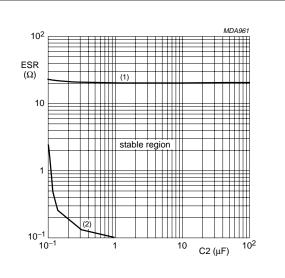
Notes

- 1. The regulator output will follow V_P if $V_P < V_{REG} + V_{REG(drop)}$.
- 2. TDA3664TT: $I_{REG} \le$ 15 mA at $T_{amb} \le$ 125 °C; $I_{REG} \le$ 30 mA at $T_{amb} \le$ 85 °C.
- 3. Limiting values as applicable for device type:
 - a) TDA3664: $V_P \le 45~V; -40~^{\circ}C \le T_{amb}~\le +125~^{\circ}C.$
 - b) TDA3664T: $V_P \le 33 \text{ V}$; $-40 \text{ °C} \le T_{amb} \le +85 \text{ °C}$.
 - c) TDA3664AT: $V_P \le 45~V; -40~^{\circ}C \le T_{amb} \le +125~^{\circ}C.$
 - d) TDA3664TT: $V_P \le 45 \text{ V}$; $-40 \text{ °C} \le T_{amb} \le +125 \text{ °C}$.

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TEST AND APPLICATION INFORMATION





- (1) Maximum ESR at 200 μ A \leq I_{REG} \leq 100 mA.
- (2) Minimum ESR only when $I_{REG} \leq 200~\mu A.$

Fig.5 Graph for selecting the value of the output capacitor C2.

Noise

The output noise is determined by the value of the output capacitor (see Table 1).

Table 1 Noise figures

OUTPUT	NOISE FIGURE (μV) ⁽¹⁾					
CURRENT I _O (mA)	C _O = 10 μF	C _O = 47 μF	C _O = 100 μF			
0.5	550	320	300			
50	650	400	400			

Note

1. Measured at a bandwidth of 10 Hz to 100 kHz.

Stability

The regulator is stabilized with an external capacitor on the output. The value of this capacitor can be selected using the diagrams shown in Figs 5 and 6. The four examples on the next page show the effects of the stabilization circuit using different values for the output capacitor.

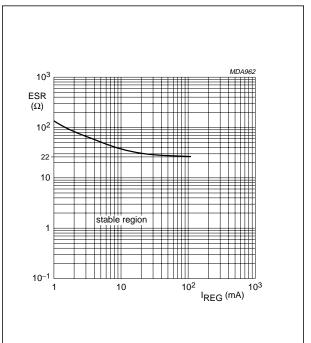


Fig.6 ESR as a function of I_{REG} for selecting the value of the output capacitor.

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EXAMPLE 1

The regulator is stabilized with an electrolytic output capacitor of 68 μ F (ESR = 0.5 Ω). At –40 °C, the capacitor value is decreased to 22 μ F and the ESR is increased to 3.5 Ω . The regulator will remain stable at a temperature of –40 °C.

EXAMPLE 2

The regulator is stabilized with an electrolytic output capacitor of 10 μF (ESR = 3.3 $\Omega).$ At –40 °C, the capacitor value is decreased to 3 μF and the ESR is increased to 20 $\Omega.$ The regulator will remain stable at a temperature of –40 °C.

EXAMPLE 3

The regulator is stabilized with a 100 nF MKT capacitor on the output. Full stability is guaranteed when the output current is over 200 μ A.

Because the thermal influence on this capacitor value is almost zero, the regulator will remain stable at a temperature of $-40~^{\circ}\text{C}$.

EXAMPLE 4

The regulator is stabilized with a 100 nF capacitor in parallel with a electrolytic capacitor of 10 μ F on the output.

The regulator is now stable under all conditions and independent of:

- The ESR of the electrolytic capacitor
- · The value of the electrolytic capacitor
- The output current.

Application circuits

The maximum output current of the regulator equals:

$$\begin{split} I_{REG(max)} &= \frac{150 - T_{amb}}{R_{th(j-a)} \times (V_P - V_{REG})} \\ &= \frac{150 - T_{amb}}{100 \times (V_P - 5)} \, (mA) \end{split}$$

When T_{amb} = 21 $^{\circ}$ C, the maximum output current equals 140 mA at V_P =14 V.

The total thermal resistance of the TDA3664 (SOT223-1 package) can be decreased to lower values when pin 4 and body of the package are soldered to the printed-circuit board.

Application circuit with backup function

Sometimes, a backup function is needed to supply, for example, a microcontroller for a short period of time when the supply voltage spikes to 0 V (or even –1 V).

This function can be easily built with the TDA3664 by using a large output capacitor. When the supply voltage is 0 V (or -1 V), only a small current will flow into pin REG from this large output capacitor (a few μ A).

The application circuit is given in Fig.7.

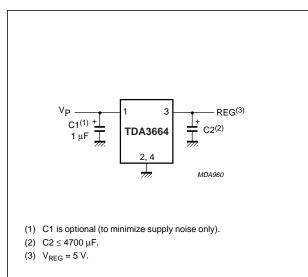


Fig.7 Application circuit with backup function (SO4 version).

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Additional application information

This section gives typical curves for various parameters measured on the TDA3664AT. Standard test conditions are: $V_P = 14.4 \text{ V}; T_{amb} = 25 \,^{\circ}\text{C}.$

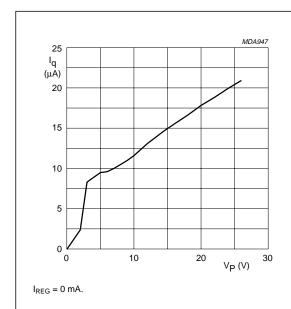
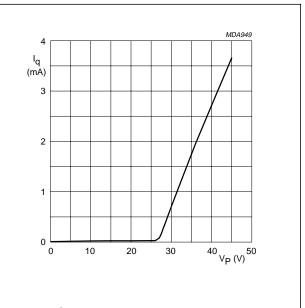


Fig.8 Quiescent current as a function of the supply voltage.



Quiescent current increase at high supply voltage.

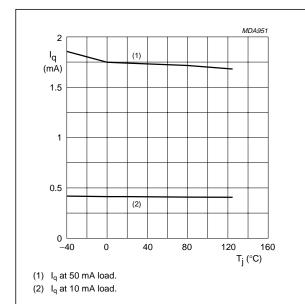
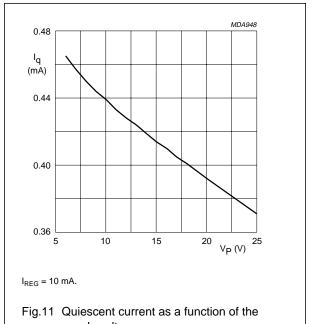


Fig.10 Quiescent current as a function of the junction temperature.



supply voltage.

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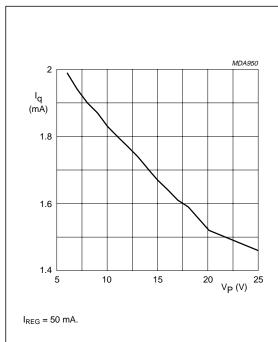


Fig.12 Quiescent current as a function of the supply voltage.

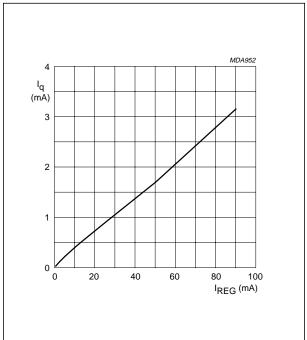
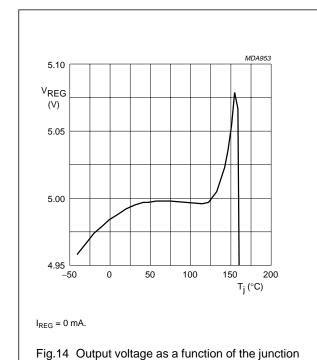
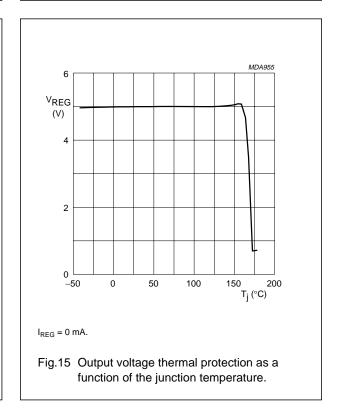


Fig.13 Quiescent current as a function of the load current.





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temperature.

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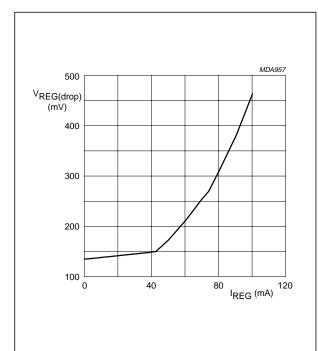
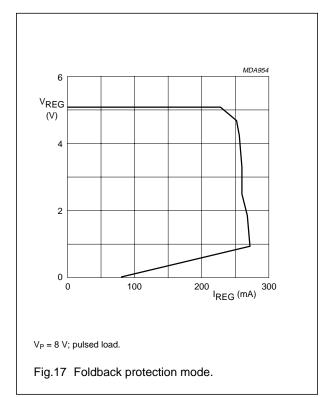
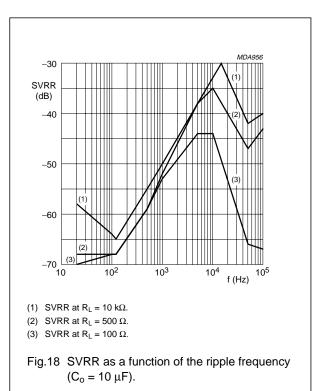


Fig.16 Dropout voltage as a function of load current.





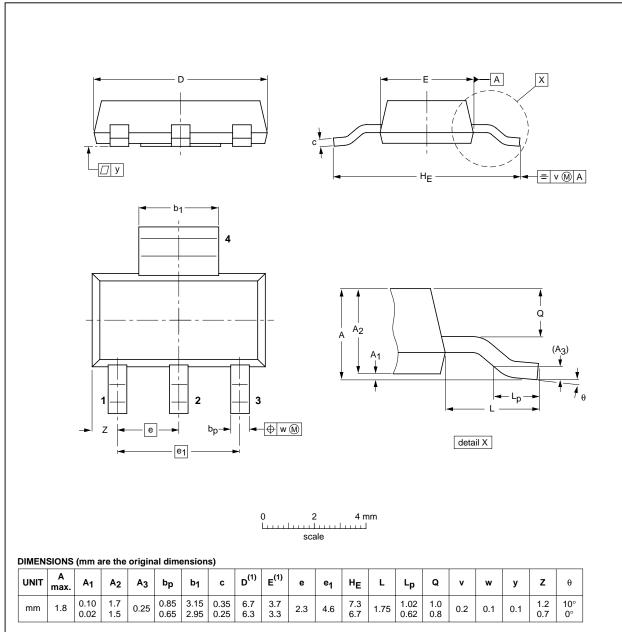
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PACKAGE OUTLINES

SO4: plastic small outline package; 4 leads; body width 3.5 mm

SOT223-1



Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFERENCES			EUROPEAN	ICCUIE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT223-1		TO-261				99-08-04 99-12-15	

TDA3664

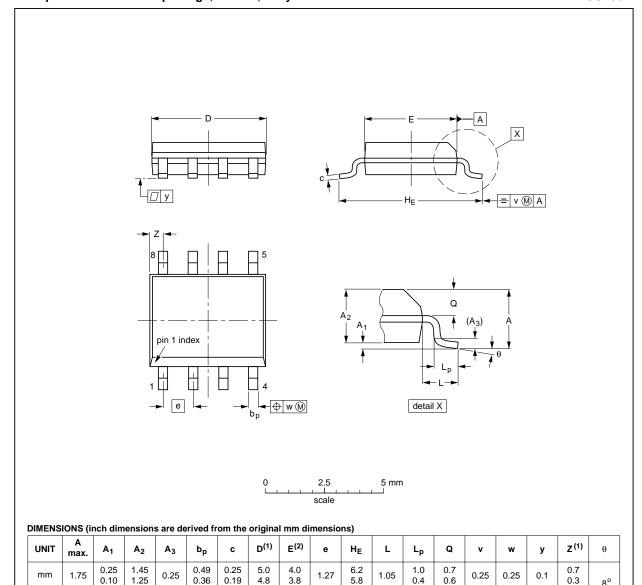
0.028

0.012

0.004

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



Notes

inches

0.010

0.004

0.069

0.057

0.049

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

0.01

0.019

0.014

0.0100

0.0075

0.20

0.19

0.16

0.15

2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFERENCES EUROPEAN ISSUE		ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT96-1	076E03	MS-012			97-05-22 99-12-27	

0.050

0.244

0.228

0.041

0.039

0.016

0.028

0.024

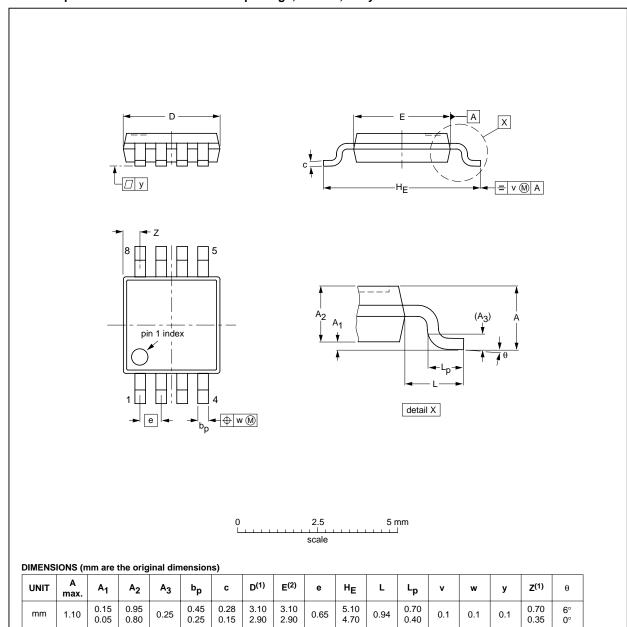
0.01

0.01

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TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm

SOT505-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTL	INE	REFERENCES			EUROPEAN	ISSUE DATE	
VERS	ION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT5	05-1						99-04-09

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SOLDERING

Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering is not always suitable for surface mount ICs, or for printed-circuit boards with high population densities. In these situations reflow soldering is often used.

Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, infrared/convection heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferable be kept below 230 °C.

Wave soldering

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Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C. A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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Suitability of surface mount IC packages for wave and reflow soldering methods

PACKAGE	SOLDERING METHOD		
PACKAGE	WAVE	REFLOW ⁽¹⁾	
BGA, LFBGA, SQFP, TFBGA	not suitable	suitable	
HBCC, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, SMS	not suitable ⁽²⁾	suitable	
PLCC ⁽³⁾ , SO, SOJ	suitable	suitable	
LQFP, QFP, TQFP	not recommended ⁽³⁾⁽⁴⁾	suitable	
SSOP, TSSOP, VSO	not recommended ⁽⁵⁾	suitable	

Notes

- 1. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods".
- 2. These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
- 3. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- 4. Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- 5. Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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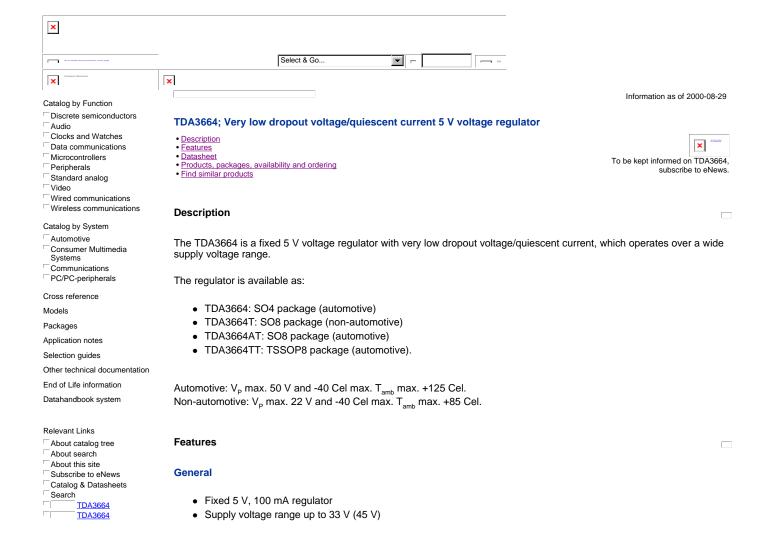
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- ESD protection on all pins
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Datasheet		

		Publication		Page	File size	
Type nr.	<u>Title</u>	release date	Datasheet status	count	(kB)	Datasheet
TDA3664	Very low dropout voltage/quiescent current 5 V voltage regulator	18-Feb-00	Preliminary Specification	20	99	Download

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